# LNJ212R8ARA

## Surface Mounting Chip LED

TSS Type

### ■ Absolute Maximum Ratings $T_a = 25$ °C

項目	記号	定格	単位	
Power dissipation	$P_{\mathrm{D}}$	50	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	$V_R$	3	V	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

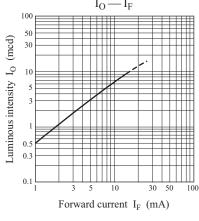
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

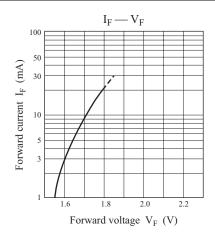
#### ■ Lighting Color

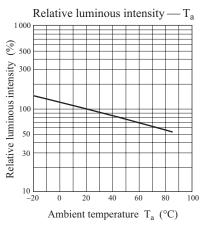
• Red

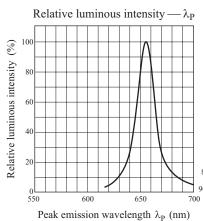
### ■ Electro-Optical Characteristics $T_a = 25$ °C

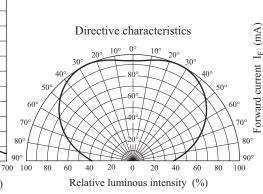
項目	記号	条件	最小	標準	最大	単位
Luminous intensity	I <sub>O</sub>	$I_F = 10 \text{ mA}$	2.2	6.7		mcd
Reverse current	$I_R$	$V_R = 3 V$			100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		1.72	2.5	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		655		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		20		nm

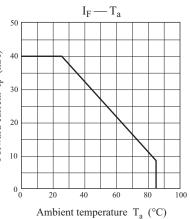








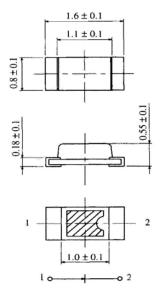




LNJ212R8ARA Panasonic

■ Package (Unit: mm)

## KLTFTN2K1200



- Pin name
  - 1: Anode
  - 2: Cathode

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